

N-channel TrenchMOS logic level FET

Rev. 02 — 17 March 2009

**Product data sheet** 

### 1. Product profile

#### **1.1 General description**

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

#### 1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Simple gate drive required due to low gate charge

#### **1.3 Applications**

- DC-to-DC convertors
- Lithium-ion battery applications
- applications due to fast switching characteristics

Suitable for high frequency

- Notebook computers
- Portable equipment

#### 1.4 Quick reference data

#### Table 1. Quick reference

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C	-	-	30	V
I <sub>D</sub>	drain current	$T_{sp} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> ; see <u>Figure 3</u>	-	-	13.8	A
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> = 25 °C; see <u>Figure 2</u>	-	-	6.25	W
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS} = 5 V; I_D = 8 A;$ $V_{DS} = 15 V; T_j = 25 °C;$ see <u>Figure 11</u>	-	3.9	-	nC
Static ch	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 8 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \underline{Figure 9};$ see $\underline{Figure 10}$	-	17	20	mΩ

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### 2. Pinning information

Table 2.	Pinning	information				
Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	S	source		2		
2	S	source				
3	S	source				
4	G	gate				
5	D	drain		mbb076 S		
6	D	drain	SOT96-1			
7	D	drain	(SO8)			
8	D	drain				

# 3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PHK13N03LT	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1		

### 4. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C	-	30	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 150 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	30	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$T_{sp} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } Figure 1; \text{ see } Figure 3$	-	13.8	А
		$T_{sp} = 100 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } Figure 1$	-	8.7	А
I <sub>DM</sub>	peak drain current	$T_{sp} = 25 \text{ °C}; t_p \le 10 \mu\text{s}; \text{ pulsed}; \text{ see } \frac{\text{Figure 3}}{10 \mu\text{s}}$	-	55	А
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> = 25 °C; see <u>Figure 2</u>	-	6.25	W
T <sub>stg</sub>	storage temperature		-55	150	°C
Tj	junction temperature		-55	150	°C
Source-dra	iin diode				
ls	source current	T <sub>sp</sub> = 25 °C	-	5.7	А
I <sub>SM</sub>	peak source current	$T_{sp} = 25 \text{ °C}; t_p \le 10  \mu s; \text{ pulsed}$	-	55	А

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## 5. Thermal characteristics

Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point	see Figure 4	-	-	20	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	minimum footprint; mounted on a printed-circuit board	-	70	-	K/W



# 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>(BR)DSS</sub> drain-source breakdown voltage	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	30	-	-	V
	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$	27	-	-	V	
$V_{GS(th)}$	gate-source threshold voltage	I <sub>D</sub> = 250 μA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 150 °C; see <u>Figure 8</u>	0.5	-	-	V
		$I_D = 250 \ \mu A; V_{DS} = V_{GS}; T_j = -55 \ ^{\circ}C;$ see <u>Figure 8</u>	-	-	2.2	V
		$I_D = 250 \ \mu\text{A}; \ V_{DS} = V_{GS}; \ T_j = 25 \ ^\circ\text{C};$ see Figure 8	1	1.5	2	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 24 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μΑ
		$V_{DS} = 24 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 100 \text{ °C}$	-	-	5	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
		$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 4.5 V; $I_D$ = 7 A; $T_j$ = 25 °C; see <u>Figure 9</u>	-	21	26	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 8 \text{ A}; T_j = 150 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 9</u>	-	-	33	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 8 \text{ A}; T_j = 25 \text{ °C};$ see <u>Figure 9</u> ; see <u>Figure 10</u>	-	17	20	mΩ
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 8 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 5 \text{ V};$	-	10.7	-	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	2.7	-	nC
Q <sub>GD</sub>	gate-drain charge		-	3.9	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 15 V; $V_{GS}$ = 0 V; f = 1 MHz;	-	752	-	pF
Coss	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 12}{\text{Figure } 12}$	-	200	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	130	-	pF
t <sub>d(on)</sub>	turn-on delay time		-	6	-	ns
t <sub>r</sub>	rise time	$V_{DS} = 15 \text{ V}; \text{ R}_{L} = 10 \Omega; \text{ V}_{GS} = 10 \text{ V};$ $R_{G(ext)} = 6 \Omega; \text{ I}_{D} = 1.5 \text{ A}; \text{ T}_{j} = 25 ^{\circ}\text{C}$	-	7	-	ns
t <sub>d(off)</sub>	turn-off delay time	$V_{DS}$ = 15 V; $R_{L}$ = 10 $\Omega$ ; $V_{GS}$ = 10 V;	-	23	-	ns
t <sub>f</sub>	fall time	$R_{G(ext)} = 6 \Omega; T_j = 25 \text{ °C}; I_D = 1.5 \text{ A}$	-	11	-	ns
Source-d	rain diode					
$V_{SD}$	source-drain voltage	I <sub>S</sub> = 7 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 13</u>	-	0.86	1.1	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 7 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	25	-	ns
Qr	recovered charge	V <sub>DS</sub> = 30 V; T <sub>j</sub> = 25 °C	-	5	-	nC





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### 7. Package outline



#### Fig 14. Package outline SOT96-1 (SO8)

PHK13N03LT\_2

# 8. Revision history

Table 7. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PHK13N03LT_2	20090317	Product data sheet	-	PHK13N03LT-01
Modifications:	<ul> <li>The format of guidelines of a source based on the sou</li></ul>	of this data sheet has been f NXP Semiconductors.	redesigned to comply wi	th the new identity
	• Legar lexis r	lave been adapted to the r	iew company name when	e appropriate.
PHK13N03LT-01	20030623	Product data sheet	-	-

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#### 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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